

**NIKO-SEM****P-Channel Logic Level Enhancement Mode  
Field Effect Transistor****PKCE9BB  
PDFN 5x6P  
Halogen-Free & Lead-Free****PRODUCT SUMMARY**

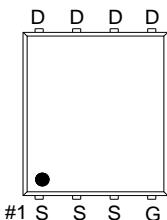
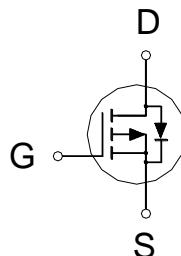
| $V_{(BR)DSS}$ | $R_{DS(on)}$ | $I_D$ |
|---------------|--------------|-------|
| -40V          | 3.95mΩ       | -92A  |

**Features**

- Pb-Free, Halogen Free and RoHS compliant.
- Low  $R_{DS(on)}$  to Minimize Conduction Losses.
- Ohmic Region Good  $R_{DS(on)}$  Ratio.
- Optimized Gate Charge to Minimize Switching Losses.

**Applications**

- Protection Circuits Applications.
- Logic/Load Switch Circuits Applications.



G. GATE  
D. DRAIN  
S. SOURCE

100% UIS Tested  
100% Rg Tested

**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)**

| PARAMETERS/TEST CONDITIONS                     | SYMBOL         | LIMITS     | UNITS |
|--|----------------|------------|-------|
| Drain-Source Voltage                           | $V_{DS}$       | -40        | V     |
| Gate-Source Voltage                            | $V_{GS}$       | $\pm 25$   | V     |
| Continuous Drain Current <sup>4</sup>          | $I_D$          | -92        | A     |
|  |                | -58        |       |
|  |                | -24        |       |
|  |                | -19        |       |
| Pulsed Drain Current <sup>1</sup>              | $I_{DM}$       | -200       |       |
| Avalanche Current                              | $I_{AS}$       | -57        |       |
| Avalanche Energy                               | $E_{AS}$       | 162        | mJ    |
| Power Dissipation <sup>3</sup>                 | $P_D$          | 62         | W     |
|  |                | 25         |       |
|  |                | 4.1        |       |
|  |                | 2.6        |       |
| Operating Junction & Storage Temperature Range | $T_j, T_{stg}$ | -55 to 150 | °C    |

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| THERMAL RESISTANCE               |              | SYMBOL          | TYPICAL | MAXIMUM | UNITS  |
|----------------------------------|--------------|-----------------|---------|---------|--------|
| Junction-to-Ambient <sup>2</sup> | $t \leq 10s$ | $R_{\theta JA}$ |         | 30      | °C / W |
| Junction-to-Ambient <sup>2</sup> | Steady-State | $R_{\theta JA}$ |         | 57      |        |
| Junction-to-Case                 | Steady-State | $R_{\theta JC}$ |         | 2       |        |

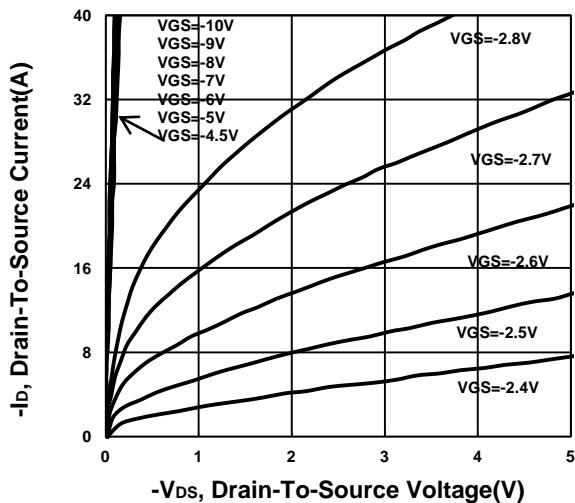
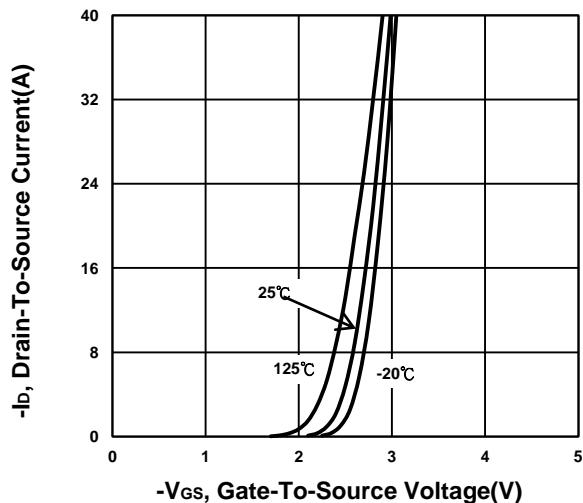
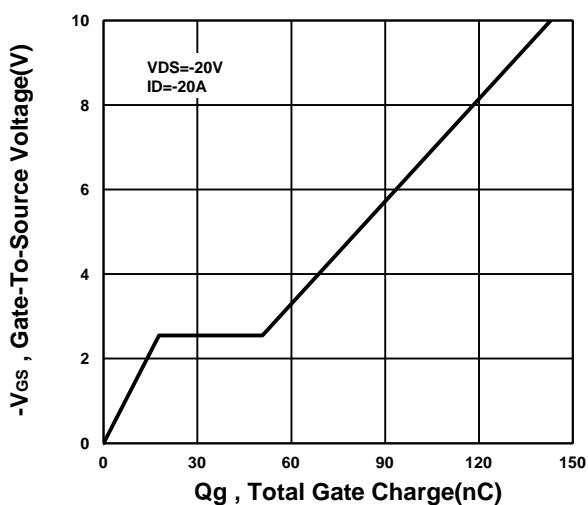
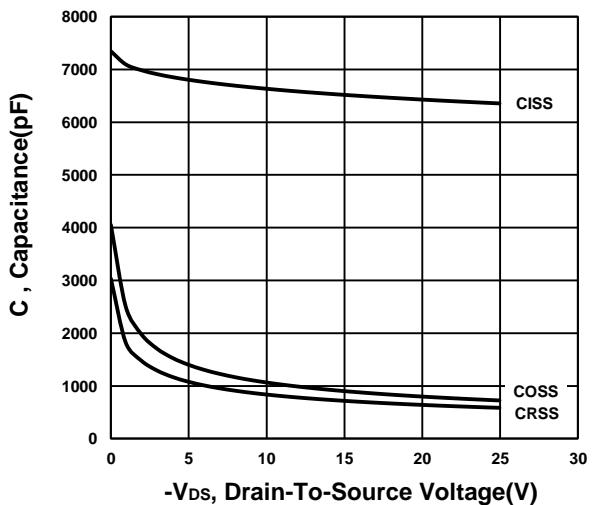
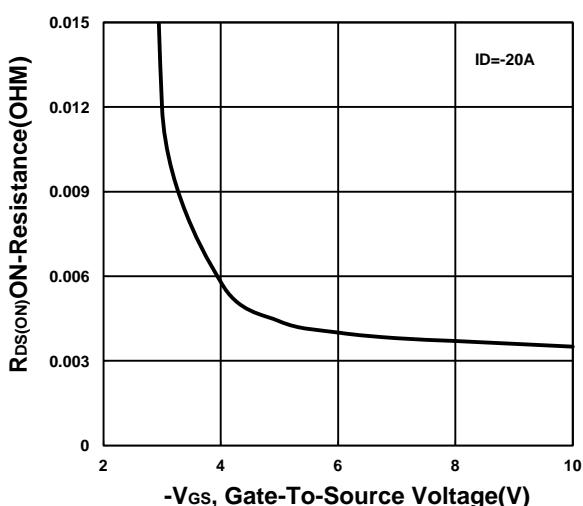
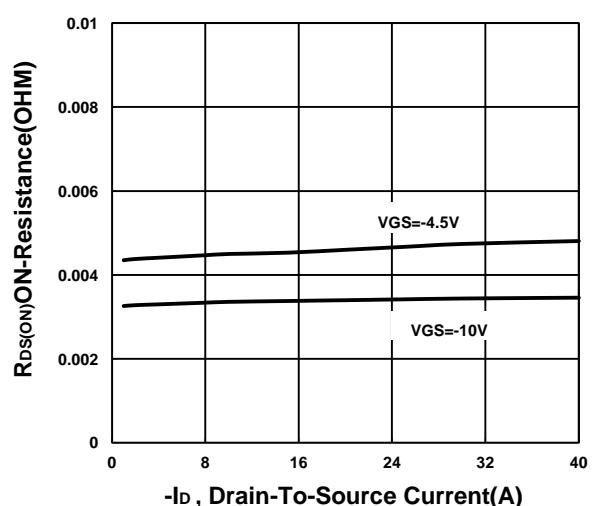
<sup>1</sup>Pulse width limited by maximum junction temperature.<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ C$ . The value in any given application depends on the user's specific board design.<sup>3</sup>The Power dissipation is based on  $R_{\theta JA} t \leq 10s$  value.<sup>4</sup>The maximum current rating is package limited.**ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ C$ , Unless Otherwise Noted)**

| PARAMETER                                     | SYMBOL        | TEST CONDITIONS  | LIMITS |      |           | UNIT      |
|---|---------------|--|--------|------|-----------|-----------|
|   |               |  | MIN    | TYP  | MAX       |           |
| <b>STATIC</b>                                 |               |  |        |      |           |           |
| Drain-Source Breakdown Voltage                | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = -250\mu A$                                     | -40    |      |           | V         |
| Gate Threshold Voltage                        | $V_{GS(th)}$  | $V_{DS} = V_{GS}, I_D = -250\mu A$                                 | -1.3   | -1.6 | -2.3      |           |
| Gate-Body Leakage                             | $I_{GSS}$     | $V_{DS} = 0V, V_{GS} = \pm 25V$                                    |        |      | $\pm 100$ | nA        |
| Zero Gate Voltage Drain Current               | $I_{DSS}$     | $V_{DS} = -40V, V_{GS} = 0V$                                       |        |      | -1        | uA        |
|   |               | $V_{DS} = -40V, V_{GS} = 0V, T_J = 55^\circ C$                     |        |      | -10       |           |
| Drain-Source On-State Resistance <sup>1</sup> | $R_{DS(ON)}$  | $V_{GS} = -10V, I_D = -20A$  |        | 3.15 | 3.95      | $m\Omega$ |
|   |               | $V_{GS} = -4.5V, I_D = -15A$                                       |        | 4.35 | 7         |           |
| Forward Transconductance <sup>1</sup>         | $g_f$         | $V_{DS} = -5V, I_D = -20A$   |        | 72   |           | S         |
| <b>DYNAMIC</b>                                |               |  |        |      |           |           |
| Input Capacitance                             | $C_{iss}$     | $V_{GS} = 0V, V_{DS} = -20V, f = 1MHz$                             |        | 6431 |           | pF        |
| Output Capacitance                            | $C_{oss}$     |  |        | 798  |           |           |
| Reverse Transfer Capacitance                  | $C_{rss}$     |  |        | 646  |           |           |
| Gate Resistance                               | $R_g$         | $V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$                               |        | 4.3  |           | $\Omega$  |
| Total Gate Charge <sup>2</sup>                | $Q_g$         | $V_{DS} = -20V, V_{GS} = -10V, I_D = -20A$                         |        | 142  |           | nC        |
| Gate-Source Charge <sup>2</sup>               | $Q_{gs}$      |  |        | 17   |           |           |
| Gate-Drain Charge <sup>2</sup>                | $Q_{gd}$      |  |        | 33   |           |           |
| Turn-On Delay Time <sup>2</sup>               | $t_{d(on)}$   | $V_{DS} = -20V, I_D \approx -20A, V_{GS} = -10V, R_{GS} = 6\Omega$ |        | 15   |           | nS        |
| Rise Time <sup>2</sup>                        | $t_r$         |  |        | 94   |           |           |
| Turn-Off Delay Time <sup>2</sup>              | $t_{d(off)}$  |  |        | 232  |           |           |
| Fall Time <sup>2</sup>                        | $t_f$         |  |        | 133  |           |           |

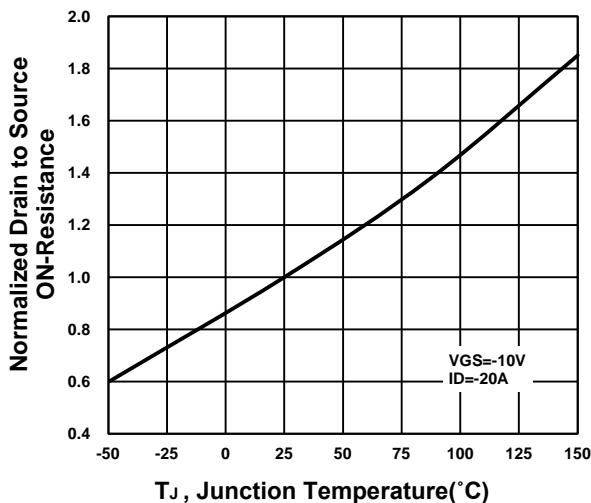
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| SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ ) |          |   |  |    |      |    |
|---|----------|---|--|----|------|----|
| Continuous Current <sup>3</sup>   | $I_S$    |   |  |    | -47  | A  |
| Forward Voltage <sup>1</sup>  | $V_{SD}$ | $I_F = -20\text{A}, V_{GS} = 0\text{V}$                     |  |    | -1.3 | V  |
| Reverse Recovery Time   | $t_{rr}$ | $I_F = -20\text{A}, dI_F/dt = 100 \text{ A / } \mu\text{s}$ |  | 26 |      | nS |
| Reverse Recovery Charge   | $Q_{rr}$ |   |  | 19 |      | nC |

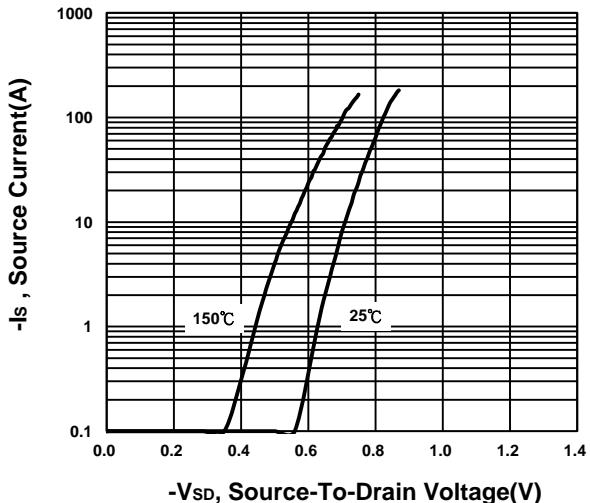
<sup>1</sup>Pulse test : Pulse Width  $\leq 300 \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .<sup>2</sup>Independent of operating temperature.<sup>3</sup>The maximum current rating is package limited.

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Halogen-Free & Lead-Free****Output Characteristics****Transfer Characteristics****Gate charge Characteristics****Capacitance Characteristic****On-Resistance VS Gate-To-Source Voltage****On-Resistance VS Drain Current**

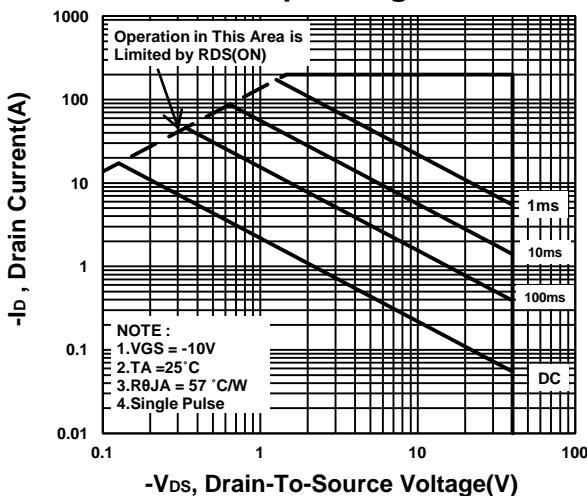
## On-Resistance VS Temperature



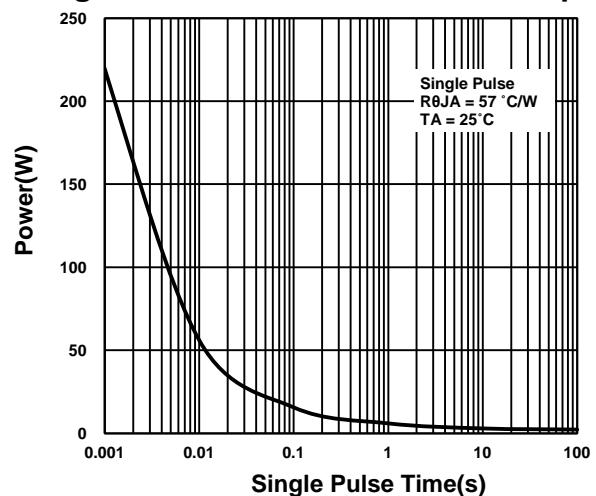
## Source-Drain Diode Forward Voltage



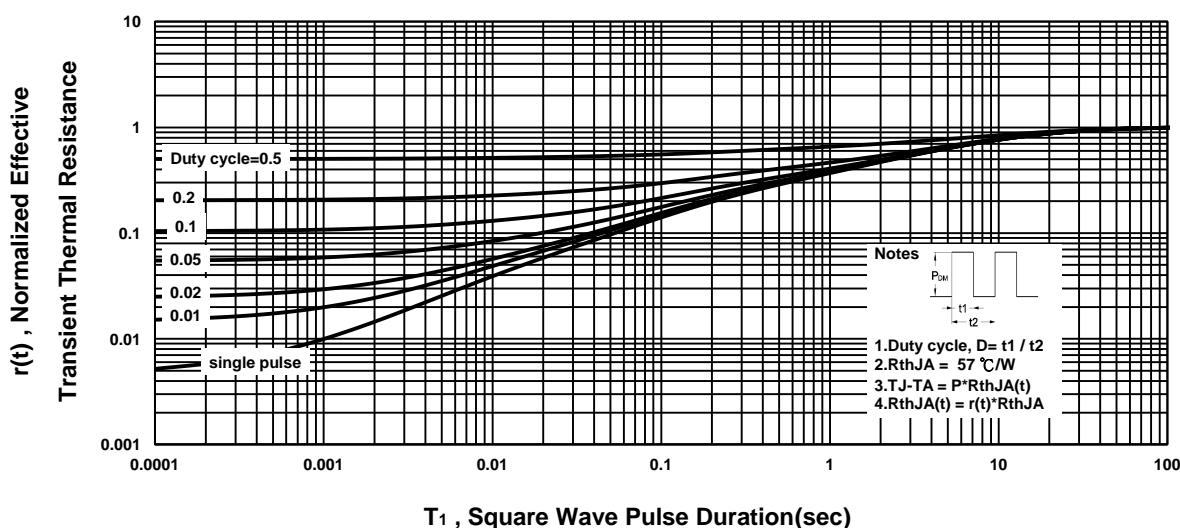
## Safe Operating Area

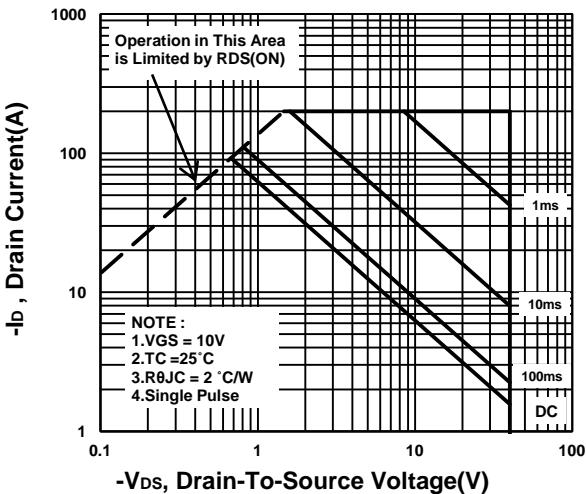
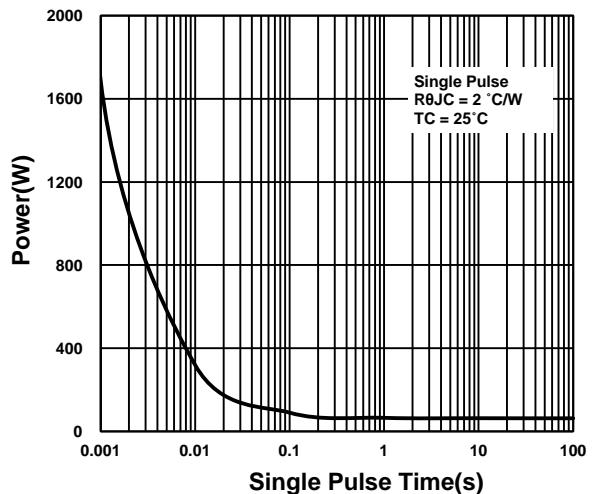


## Single Pulse Maximum Power Dissipation



## Transient Thermal Response Curve



**Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**